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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE 700

Applicant(s): Hidemitsu Aoki, et al.

Examiner:

Saeed Chaudhry

Serial No.:

10/075,566

Art Unit:

1746

Filed:

February 13, 2002

Docket:

12688A

For:

METHOD FOR CLEANING

Dated:

December 15, 2003

SEMICONDUCTOR WAFER AFTER CHEMICAL MECHANICAL POLISHING

ON COPPER WIRING

Commissioner for Patents Mail Stop Non-Fee Amendment Arlington, VA 22313

RESPONSE PURSUANT TO 37 C.F.R. §1.115

Sir:	· · · · · · · · · · · · · · · · · · ·
	In response to the office action of October 7, 2003, the applicants submit the
following resp	oonse.

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(2)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, M.S. Non-Fee Amendment, Arlington, VA 22313 on December \$\sqrt{5}\gamma\circ{2}003\$.

Dated: December 15, 2003

Richard J. Danyko

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AMENDMENT TRANSMITTAL LETTER (Large Entity) Applicant(s): Hidemitsu AOKI, et al.								Docket No. 12688A		
Serial No.		Filin	g Date	E	xaminer		Group Art Unit			
10/075,566			February 13, 2002		Saeed Chaudhry		1746			
10,0,0,0,000	10/0/3,300 Pebluary 13, 2002 Saccu Chaudiny					,	17.00			
Invention: METHOD FOR CLEANING SEMICONDUCTOR WAFER AFTER CHEMICAL MECHANICAL										
POLISHING COPPER WIRING										
01 20								NECEIVED		
TO THE COMMISSIONER FOR PATENTS:						1	DEC 2 9 2003			
TC 1700										
Transmitted he with is an expendment in the above-identified application.										
The fee has been	calcula	ted and is trans	mitted as shown	below.						
CLAIMS AS AMENDED										
	CLAIM	S REMAINING	HIGHEST#	NUMBE	R EXTRA			ADDITIONAL		
,	AFTER	AMENDMENT	PREV. PAID FOR	CLAIMS	PRESENT	RATE		FEE		
TOTAL CLAIMS	4:	2 -	42 =		0	x \$18.	.00	\$0.00		
INDEP. CLAIMS	4		4 =		0	x \$86.	.00	\$0.00		
Multiple Dependent Claims (check if applicable) \$0.00										
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT \$0.00										
No additional fee is required for amendment. Please charge Deposit Account No: A check in the amount of to cover the filing fee is enclosed. The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. Any additional filing fees required under 37 C.F.R. 1.16. Any patent application processing fees under 37 CFR 1.17. Dated: December 15, 2003 Richard J. Danyko Registration No. 33,672 SCULLY, SCOTT, MURPHY & PRESSER 400 Garden City Plaza Garden City, New York 11530 (S16) 742-4343 RJD/ej										
Signature (
Richard J. Danyko										

Typed or Printed Name :::